

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT3880275

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MAYAN MOUDGILL	05/12/2016
GARY NACER	04/20/2016
C. JOHN GLOSSNER	05/12/2016
A. JOSEPH HOANE	04/21/2016
MURUGAPPAN SENTHILVELAN	04/25/2016
PABLO BALZOLA	04/20/2016
RECEIVING PARTY DATA	
Name:	OPTIMUM SEMICONDUCTOR TECHNOLOGIES, INC.
Street Address:	120 WHITE PLAINS ROAD
Internal Address:	4TH FLOOR
City:	TARRYTOWN
State/Country:	NEW YORK
Postal Code:	10591
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15087204
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	26067-31
NAME OF SUBMITTER:	RAYMOND G. CAPPO
SIGNATURE:	/Raymond G. Cappo/
DATE SIGNED:	05/19/2016

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Total Attachments: 7

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ASSIGNMENT

WHEREAS, WE, Mayan Moudgill, a citizen of the United States residing in Chappaqua, New York, **Gary Nacer**, a citizen of the United States, residing in Morris Plains, New Jersey, **C. John Glossner**, a citizen of the United States residing in Nashua, New Hampshire, **A. Joseph Hoane**, **Paul Hurtle**, a citizen of the United States, residing in White Plains, New York, **Murugappan Senthilvelan**, a citizen of the United States, residing in Carmel, New York, and **Pablo Balzola**, a citizen of Spain residing in Madrid, Spain, ("ASSIGNOR"), have invented, developed, and/or have rights in the invention(s) ("THE INVENTION(S)") disclosed in United States Patent Application No. 15/087,204, filed March 31, 2016 (herein the "Patent");

AND WHEREAS Optimum Semiconductor Technologies, Inc., a corporation having a principal place of business at 120 White Plains Road, 4th Floor, Tarrytown, NY 10591, ("ASSIGNEE") desire to acquire the entire (100%) right, title, and interest in and to THE INVENTION(S) and in and to the Patent;

NOW, THEREFORE, in consideration of the sum of one dollar (\$1.00) in hand and/or other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned, transferred and set over, and do hereby sell, assign, transfer and set over to ASSIGNEE the entire right, title and interest in and to THE INVENTION(S) and the Patent and all patents and patent applications claiming priority to and/or benefit of the Patent including utilities, divisions, continuations, and continuations-in-part thereof and all reissues, reexaminations, and extensions thereof, and all priority rights under the International Convention for the Protection of Industrial Property for every member country, and all applications for patents (including related rights such as utility-model registrations, registrations, inventor's certificates, and the like) heretofore or hereafter filed for THE INVENTION(S) in any foreign country/countries, and all patents (including all extensions, renewals and reissues thereof) granted for THE INVENTION(S) and the Patent in any foreign country/countries;

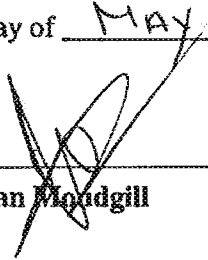
AND WE HEREBY authorize and request the United States Commissioner of Patents and Trademarks, and any officials of foreign countries whose duty is to issue patents on applications as aforesaid, to issue all patents for THE INVENTION(S) and/or the Patent in the name of ASSIGNEE in accordance with the terms of this assignment;

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith;

AND WE HEREBY further covenant and agree that we will communicate to ASSIGNEE any facts known to us respecting THE INVENTION(S) and the Patent, sign all lawful papers, execute all divisional, continuation, continuations-in-part, substitute, reexamination, and reissue applications, make all rightful oaths and generally do everything possible to aid ASSIGNEE to obtain and enforce proper patent protection for THE INVENTION(S) and the Patent.

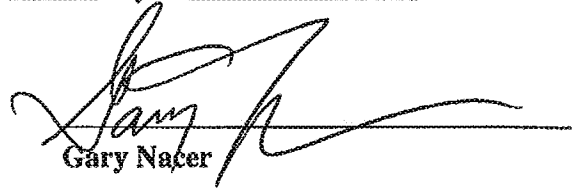
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In testimony whereof, I hereunto set my hand this 12 day of MAY, 2016.

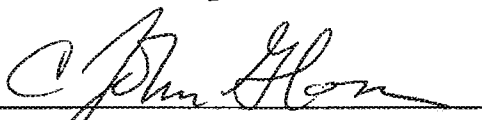


Mayan Moudgill

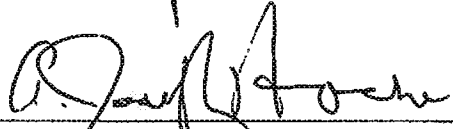
In testimony whereof, I hereunto set my hand this 20 day of APRIL, 2016.


Gary Nacer

In testimony whereof, I hereunto set my hand this 12 day of May, 2016.

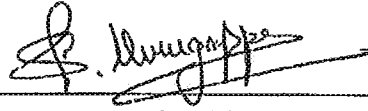

C. John Glossner

In testimony whereof, I hereunto set my hand this 21st day of April, 2016.



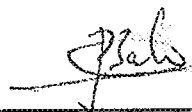
A. Joseph Hoane

In testimony whereof, I hereunto set my hand this 25th day of APR 12, 2016.

A handwritten signature in black ink, appearing to read "Murugappan Senthilvelan", written over a horizontal line.

Murugappan Senthilvelan

In testimony whereof, I hereunto set my hand this 20th day of April, 2016.



Pablo Balzola